

User's Guide SLVU241-April 2008

# TPS60255EVM-262

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#### 1 Introduction

The Texas Instruments TPS60255EVM-262 evaluation module (EVM) helps designers evaluate the operation and performance of the TPS60255 white LED (WLED) driver for applications that are powered with one Li-ion or Li-polymer cell and require two or three separate banks of WLEDs. The TPS60255 contains a 1×/1.5× chargepump, as well as one group of four 25mA WLED current regulators, one group of two 25 mA WLED current regulators and a 80mA LED current regulator, capable of driving several WLEDs in parallel. Each group's current level is independently controllable by three independent brightness registers and five ON/OFF bits via a single-wire interface (EasyScale<sup>TM</sup>)



#### Setup

# 2 Setup

This chapter describes the jumpers and connectors on the EVM, as well as how to properly connect, set up, and use the TPS60255EVM-262.

#### 2.1 Input/Output Connector Descriptions

#### J1 – VIN

This is the positive input voltage connection to the converter. The EVM operates from any supply voltage between 2.7 V and 6 V. The leads to the input supply should be twisted and kept as short as possible to minimize EMI transmission and input voltage droop.

#### J2 – GND

This is the input return connection for the input power supply.

#### J3 – USB to GPIO Connector

This is the connector for the interface box. Connect the ribbon cable of the interface box to this device.

# J4 – VLED ANODE

This is the anode connection when using external WLEDs. The cathode for external WLEDs can be connected to the appropriate side of jumper JP1-JP7. This connection can also be used to measure the voltage and/or voltage ripple at the VOUT pin of the device.

#### J5 – AUX

This is the cathode connection when using external WLEDs connected to Group C.

#### JP1 – DA1

JP1 is used to connect the cathode of the DA1 LED to the GA1 pin on the TPS60255. Place a shunt on JP1 to connect the WLED to the GA1 input pin. Remove the shunt and place an ammeter in series to measure the DA1 current or attach an external WLED using this jumper.

# JP2 – DA2

JP2 is used to connect the cathode of the DA2 LED to the GA2 pin on the TPS60255. Place a shunt on JP2 to connect the WLED to the GA2 input pin. Remove the shunt and place an ammeter in series to measure the DA2 current or attach an external WLED using this jumper.

# JP3 – DA3

JP3 is used to connect the cathode of the DA3 LED to the GA3 pin on the TPS60255. Place a shunt on JP3 to connect the WLED to the GA3 input pin. Remove the shunt and place an ammeter in series to measure the DA3 current or attach an external WLED using this jumper.

#### JP4 – DA4

JP4 is used to connect the cathode of the DA4 LED to the GA4 pin on the TPS60255. Place a shunt on JP4 to connect the WLED to the GA4 input pin. Remove the shunt and place an ammeter in series to measure the DA4 current or attach an external WLED using this jumper.

#### JP5 – DC1-DC6

JP5 is used to connect the cathode of the DC1-DC6 LEDs to the GC pin on the TPS60255. Place a shunt on JP5 to connect the DC1-DC6 WLEDs to the GC input pin. Remove the shunt and place an ammeter in series to measure the DC1-DC6 current or attach external WLEDs using this jumper.

#### JP6 – DB1

JP6 is used to connect the cathode of the DB1 LED to the GB1 pin on the TPS60255. Place a shunt on JP6 to connect the WLED to the DB1 input pin. Remove the shunt and place an ammeter in series to measure the DB1 current or attach an external WLED using this jumper.



#### JP7 – DB2

JP7 is used to connect the cathode of the DB2 LED to the GB2 pin on the TPS60255. Place a shunt on JP7 to connect the WLED to the DB2 input pin. Remove the shunt and place an ammeter in series to measure the DB2 current or attach an external WLED using this jumper.

# JP8 – EN

This jumper enables the device by tying the ENA pin to VIN, if set to ON or disables the device by tying the ENA pin to GND, if set to OFF.

# 2.2 Equipment Requirements

In order for this EVM to operate properly, the following components must be connected and properly configured.

#### 2.2.1 Personal Computer

A Windows based computer with a USB port is required to operate this EVM. The TPS60255 interface software, which is run on the personal computer (PC), communicates with the EVM via the PC USB port. The user sends commands to the EVM and reads the contents of the TPS60255 internal registers through the USB port.

# 2.2.2 USB-TO-GPIO Adapter

The HPA172 USB-TO-GPIO Adapter is the communications link between the PC and the EVM. The adapter connects to the PC with the supplied USB cable on one side and to the EVM though the supplied ribbon cable on the other. When the user writes a command to the EVM, the interface program, which is run from the PC, sends the command to the PC USB port. The adapter receives the USB command and converts the signal to the one-wire EasyScale<sup>TM</sup> protocol and sends it to the TPS60255 IC via the IF pin. The EasyScale protocol is a write only protocol, with the IC only being able to respond to the software by pulling the IF pin low to indicate it has received the signal. If the software's ACK box is checked, the software will mointor for this low signal and give an error message if it is not received.

#### 2.2.3 Software

Texas Instruments provides software to assist the user in evaluating this EVM. To install the software, insert the enclosed CD into your computer. The software should start automatically. If it does not, go to <Start>, <Run>, and type *D*:\setup.exe, and click <OK> (assuming that D: is your CD drive). If the PC is connected to the internet, the software will automatically search for updates. Alternatively, the user can manually check the TPS60255 product folder on the TI Web site for the latest version of the software.

#### 2.2.4 Power Supplies

The TPS60255 EVM requires one power supply set not larger than 6 V and capable of providing at least 1A for operation.



JP8 – EN

# 2.3 Operation

The following steps must be followed before the EVM can be operated.

- 1. Install the TPS60255EVM software on the PC.
- 2. Connect a 2.7-V to 6.0-V input power supply to the EVM.
- 3. Configure JP1-JP7 to the factory jumper settings in Table 1.
- 4. Connect the ribbon cable between the EVM and the USB-TO-GPIO (HPA172) adapter.
- 5. Connect the USB cable between the computer and USB-TO-GPIO adapter
- 6. Place JP8 to ON to enable the IC.
- 7. Run the TPS60255EVM software.

Jumper	Shunt Location
JP1	Installed
JP2	Installed
JP3	Installed
JP4	Installed
JP5	Installed
JP6	Installed
JP7	Installed
JP8	OFF

# Table 1. Factory EVM Jumper Settings

#### 2.3.1 TPS60255 Software Operation

A screenshot of the software is shown in Figure 1. The users can either directly change the registers or use the check boxes and drop down boxes to change the registers. Note that either the Write button for the individual registers or the Write To All Registers button must be pressed before a change to the IC is made.

# 2.3.1.1 Display Enable Settings

This screen section allows the user to enable/disable the different banks of LEDs using simple check boxes.

# 2.3.1.2 Current Level Settings

This screen section allows the user to select the LED current for each of the banks of LEDs. The LEDs installed on the EVM are rated for 30-mA dc current and may be damaged at higher currents.

#### 2.3.1.3 General Device Settings

This screen section displays the device address. The Mode Select drop down box allows the user to set the chargepump's mode between Shutdown,  $1.0 \times \text{mode}$ ,  $1.5 \times \text{mode}$  or to Auto select between  $1.0 \times \text{ or}$   $1.5 \times \text{mode}$  depending on the input voltage and LED current. Refer to the data sheet for a detailed description of the available modes. Selecting the shutdown option in this pulldown menu disables all of the LEDs and places the IC in a low-power shutdown mode.



#### 2.3.1.4 Device Register Map

This screen section allows the user to change the registers on a bit level. When selecting a bit in the register map, the description of the bit is shown on the bottom bar of the software.

🔡 TP560255 Control Software ¥.1.0.0.11	
File Support Help	
Silicon Revision ID: 1 HPA Design Tools	
Silicon Revision ID: 1 HPA Design Tools  Display Enable Settings  Display Enable Group B1 Enable Group B1 Enable Group B2 Enable Group C  Current Level Settings Group B Display Current 0.1mA Group C Display Current 20%(00) General Device Settings Device Address 01000010 Mode Selection Auto(00)  Enable IF	EasyScale Settings         Speed (KBits/s)         100         Image: Control (KBits/s)         Image: Control (KBits/s)      <
	.::

Figure 1. TPS60255 Software User Interface

# 3 Board Layout

This chapter provides the TPS60255EVM-262 board layout and illustrations.

# 3.1 Layout

Board layout is critical for all switch-mode power supplies. Figure 2 through Figure 4 show the board layout for the TPS60255EVM-262 PWB.



Figure 2. Assembly Layer





Figure 3. Top Layer Routing





Figure 4. Bottom Layer Routing



# 4 Schematic and Bill of Materials

This chapter provides the TPS60255EVM-262 schematic and bill of materials.

# 4.1 Schematic







# 4.2 Bill of Materials

Count	RefDes	Value	Description	Size	Part Number	MFR
1	C1	1.0 μF	Capacitor, Ceramic, 25V, X5R, 10%	0603	GRM188R61E105KA12	Murata
2	C2, C3	2.2 μF	Capacitor, Ceramic, 10V, X5R, 10%	0603	GRM188R61A225KE34	Murata
1	C4	4.7 μF	Capacitor, Ceramic, 10V, X5R, 10%	0805	GRM21BR61A475KA73	Murata
6	DC1–DC6	NSSW100CT	Diode. LED, White	0.079 x 0.118 inch	NSSW100CT	Nichia
4	DA1–DA4	NSSW100CT	Diode. LED, White	0.079 x 0.118 inch	NSSW100CT	Nichia
2	DB1, DB2	NSSW100CT	Diode. LED, White	0.079 x 0.118 inch	NSSW100CT	Nichia
4	J1, J2, J4, J5	PTC36SAAN	Header, 2 pin, 100mil spacing, (36-pin strip)	0.100 x 2	PTC36SAAN	Sullins
1	J3	2510-6002UB	Connector, Male Straight 2x5 pin, 100mil spacing, 4 Wall	0.338 x 0.788 inch	2510-6002UB	ЗМ
7	JP1–JP7	PTC36SAAN	Header, 2 pin, 100mil spacing, (36-pin strip)	0.100 x 2	PTC36SAAN	Sullins
1	JP8	PTC36SAAN	Header, 3 pin, 100mil spacing, (36-pin strip)	0.100 x 3	PTC36SAAN	Sullins
6	R1-R6	10	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	R7	1.82K	Resistor, Chip, 1/16W, 1%	0603	Std	Std
1	U1	TPS60255RTE	IC, High Efficiency Charge Pump for WLED Driver with EasyScale	QFN-16	TPS60255RTE	ΤI
1	-		PCB, 2.25 ln x 2.25 ln x 0.062 ln		HPA262	Any
8	-		Shunt, 100mil, Black	0.1	929950-00	3M

#### Table 2. TPS60255EVM-262 Bill of Materials

# **Related Documentation From Texas Instruments**

TPS60255 data sheet (SLVS825)

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